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	70855050-X		
	A3	A1	0755-33810388
	(Printed Circuit Board PCB ) (High Density Interconnection HDI ) (Flexible Printed Circuit FPC ) (Rigid Printed Circuit Board 3C ISO9001 ISO14001 ISO14064 OHSAS18001 QC080000		

					1		
			/	mg/L		mg/L	
				96.4	131.92	280	
				11.18	16.68	40	
					1		
			/	mg/m3		mg/m3	
				2.05	1.76	7	
				3.37	2.88	30	
				0.4	0.32	30	
					13133.7		
					1653.18		
					1087.48		

		17.42
		20.72
		8.82
		2.83
		14.06
		39.68
		7.82
		1.07
		0.76
		64.81
		168.09

	Leq	Leq	Leq	Leq	
1	57.9	47.4	65	55	
1	58.2	47.7			
1	58.7	48.2			
1	58.1	47.7			

		2006 12	12000 /	
		2006 12	133.3 /	

( )		2005-12- 23	[2005] 213			
( )		2009-09- 08	[2009] 10091 7			

( )					2007/ 7/19	[2007] 075
( )					2009/ 2/9	[2009] 021
( )					2011/4 /11	[2011] 026

			2014-3-10
1	"		
2	"		

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3	

	<p><a href="http://www.epinfo.org">http://www.epinfo.org</a></p> <p>2013 12 16                      2015</p> <p>   2015 10 23</p>
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	1.	COD	pH			
	2.			2011	3	31
				2019	3	31
	3.				500	RMB

2016年3月15日